Power MOSFET

30 V, 30 A, Single N-Channel, SO₋₈ Flat Lead

Features

- Low R_{DS(on)}
- Fast Switching Times
- Low Inductance SO-8 Package
- These are Pb-Free Devices

Applications

- Notebooks, Graphics Cards
- Low Side Switch
- DC-DC

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	30	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain Current	Steady	$T_A = 25^{\circ}C$	۱ _D	18	А
(Note 1)	State	$T_A = 85^{\circ}C$		13	
	t ≤10 s	$T_A = 25^{\circ}C$		30	
Power Dissipation (Note 1)	Steady State	T _A = 25°C	P _D	2.3	W
	$t \le 10 s$			6.1	
Continuous Drain Current	Steady State	$T_A = 25^{\circ}C$	I _D	11	А
(Note 2)		T _A = 85°C		8.0	
Power Dissipation (Note 2)		T _A = 25°C	PD	0.9	W
Pulsed Drain Current	t _p =	10 μs	I _{DM}	89	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 150	°C
Source Current (Body Diode)			I _S	8.0	А
Single Pulse Drain-to-Source Avalanche Energy (V _{DD} = 30 V, V _{GS} = 10 V, I _{PK} = 29 A, L = 1 mH, $R_G = 25 \Omega$)			E _{AS}	421	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State		1.3	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	53.7	
Junction-to-Ambient – t \leq 10 s (Note 1)	$R_{\theta JA}$	20.5	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	138.5	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

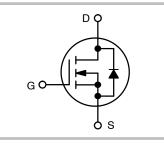
2. Surface mounted on FR4 board using the minimum recommended pad size (Cu area = 0.412 in sq).

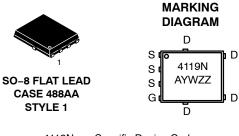


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V _{(BR)DSS}	R _{DS(on)} Typ	I_D Max (Note 1)
30 V	2.3 mΩ @ 10 V	30 A
30 V	3.1 mΩ @ 4.5 V	007







ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4119NT1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel
NTMFS4119NT3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel

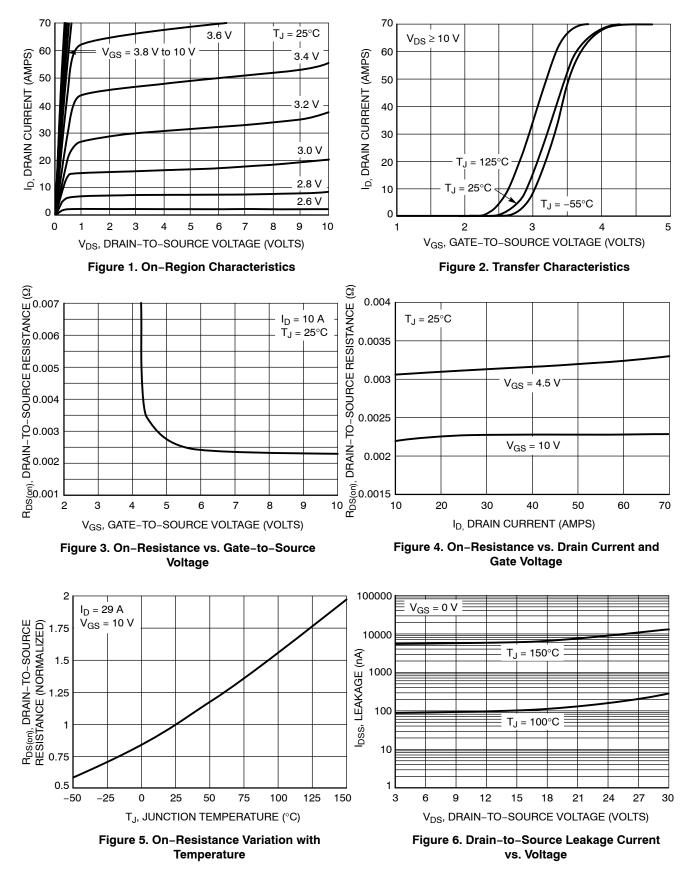
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-	-		-		-	-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				19		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 24 V	T _J = 25°C			1.0	μΑ
			T _J = 125°C			10	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} =	= 20 V			100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μΑ	1.0		2.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				7.0		mV/°C
Drain-to-Source On Resistance			29 A		2.3	3.5	mΩ
	. ,	V _{GS} = 4.5 V, I _D = 25 A			3.1	4.8	
Forward Transconductance	g fs	V _{DS} = 15 V, I _D = 10 A			23		S
CHARGES, CAPACITANCES AND GATE R	ESISTANCE						
Input Capacitance	C _{ISS}				4800		pF
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1.0 MHz, V_{DS} = 24 V			800		
Reverse Transfer Capacitance	C _{RSS}				530		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 15 V, I _D = 18 A			36.8	60	nC
Threshold Gate Charge	Q _{G(TH)}				7.3		1
Gate-to-Source Charge	Q _{GS}				11		
Gate-to-Drain Charge	Q _{GD}				17.4		1
Gate Resistance	R _G				0.73		Ω
SWITCHING CHARACTERISTICS, V _{GS} = 4.	5 V (Note 4)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I _D = 1.0 A, R _G = 3.0 Ω			28		ns
Rise Time	t _r				26		-
Turn-Off Delay Time	t _{d(OFF)}				35		
Fall Time	t _f				40		
DRAIN-SOURCE DIODE CHARACTERISTI	CS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 8.0 A	T _J = 25°C		0.74	1.0	V
			T _J = 125°C		0.56		1
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 8.0 A			36.5		ns
Charge Time	t _a				19.3		
Discharge Time	t _b				19.8		
Reverse Recovery Charge	Q _{RR}				37		nC

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES

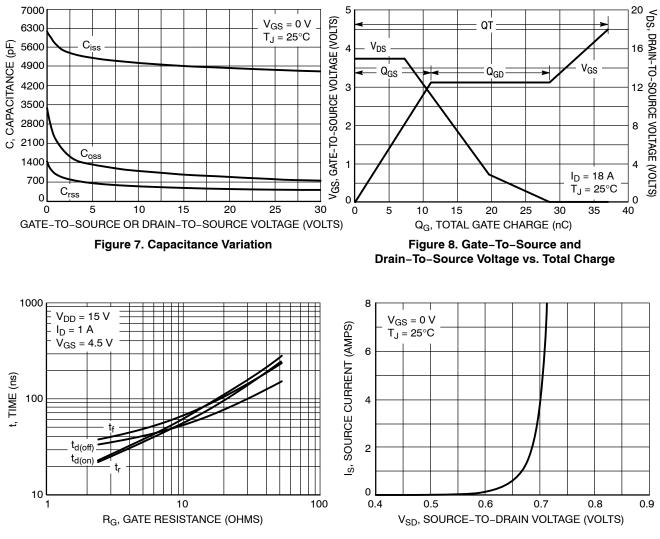
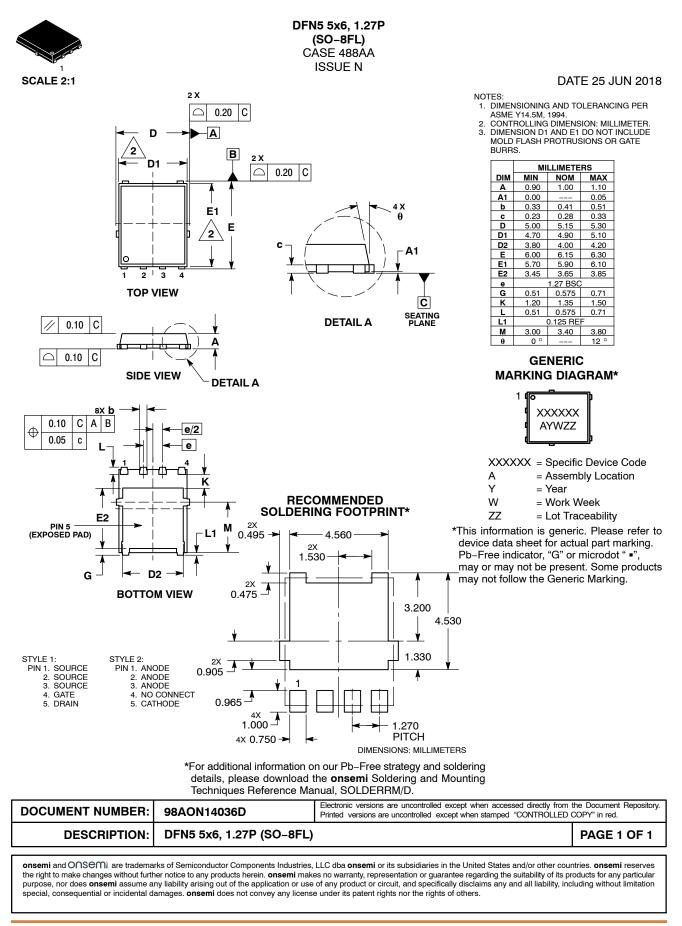


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

Figure 10. Diode Forward Voltage vs. Current

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